

Abstracts

A Technique for Correction of Parasitic Capacitance on Microwave $f_{\text{sub } t}$ Measurements of MESFET and HEMT Devices (Short Papers)

M. Feng, C.L. Lau and C. Ito. "A Technique for Correction of Parasitic Capacitance on Microwave $f_{\text{sub } t}$ Measurements of MESFET and HEMT Devices (Short Papers)." 1991 Transactions on Microwave Theory and Techniques 39.11 (Nov. 1991 [T-MTT]): 1880-1882.

The current gain cutoff frequency, $f_{\text{sub } t}$, has become a critical figure-of-merit for evaluating performance of MESFET and HEMT devices. The $f_{\text{sub } t}$ is related to a capacitance parameter, $C_{\text{sub tot}}$, through the equation $f_{\text{sub } t} = G_m / (2\pi C_{\text{sub tot}})$. This capacitance, however, includes a parasitic component primarily due to contact pad and device geometry as well as a parasitic component due to R_d , R_s and R_{ds} . This paper describes a technique which determines this parasitic capacitance for FET-type devices. Consistently accurate corrections can then be made to reported $f_{\text{sub } t}$ values. Ion implanted InGaAs MESFETs with 0.25 μ gate lengths have achieved 120 GHz $f_{\text{sub } t}$, before correction and 151 GHz $f_{\text{sub } t}$ after correction.

 [Return to main document.](#)